

AMPMODU | AMPMODU Headers

TE Internal #: 280371-2

PCB Mount Header, Vertical, Board-to-Board, 4 Position, 2.54 mm [. 1 in] Centerline, Partially Shrouded, Gold, Through Hole - Solder,

AMPMODU Headers

View on TE.com >

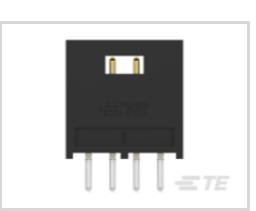


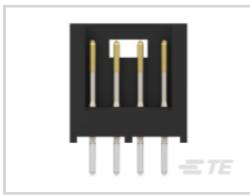
Connectors > PCB Connectors > PCB Headers & Receptacles











PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 4
Number of Rows: 1

Features

Product Type Features

| Connector Shape | Rectangular |
|-----------------------------------|-----------------------|
| PCB Connector Assembly Type | PCB Mount Header |
| Connector System | Board-to-Board |
| Header Type | Partially Shrouded |
| Sealable | No |
| Connector & Contact Terminates To | Printed Circuit Board |

Configuration Features

| Connector Contact Load Condition | Fully Loaded |
|----------------------------------|--------------|
| PCB Mount Orientation | Vertical |
| Number of Positions | 4 |
| Number of Rows | 1 |

Electrical Characteristics

| Dielectric Withstanding Voltage (Max) | 750 V |
|---------------------------------------|--------|
| Operating Voltage | 40 VAC |



Body Features

| ody i eatures | |
|---|-----------------------|
| Connector Profile | Standard |
| Primary Product Color | Black |
| Contact Features | |
| Contact Mating Area Length | 6.6 mm[.259 in] |
| Mating Square Post Dimension | .63 mm[.025 in] |
| PCB Contact Termination Area Plating Material Thickness | 2.5 μm[98.42 μin] |
| Contact Layout | Inline |
| Contact Underplating Material Thickness | 1.27 μm[50 μin] |
| Contact Shape & Form | Square |
| Contact Mating Area Plating Material Finish | Bright |
| Contact Underplating Material | Nickel |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Brass |
| Contact Mating Area Plating Material | Gold |
| Contact Mating Area Plating Material Thickness | .381 μm[15 μin] |
| Contact Type | Pin |
| Contact Current Rating (Max) | 3 A |
| ermination Features | |
| Termination Post & Tail Length | 3.5 mm[.138 in] |
| Termination Method to PCB | Through Hole - Solder |
| Mechanical Attachment | |
| Mating Retention | With |
| Panel Mount Feature | Without |
| Mating Alignment | With |
| Mating Alignment Type | Polarization |
| PCB Mount Retention | Without |
| PCB Mount Alignment | Without |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| | |
| Centerline (Pitch) | 2.54 mm[.1 in] |



Dimensions

| Connector Length | 12.7 mm[.5 in] |
|--------------------|------------------|
| Connector Height | 12.6 mm[.496 in] |
| Connector Width | 5 mm[.197 in] |
| Row-to-Row Spacing | 2.54 mm[.1 in] |

Usage Conditions

| Housing Temperature Rating | Standard |
|-----------------------------|---------------------------|
| Operating Temperature Range | -40 - 80 °C[-40 - 176 °F] |

Operation/Application

| Circuit Application | Power & Signal |
|---------------------|----------------|
|---------------------|----------------|

Industry Standards

| Industry Standard | IEC |
|------------------------|----------|
| UL Flammability Rating | UL 94V-0 |

Packaging Features

| Packaging Quantity | 1000 |
|--------------------|-------------|
| Packaging Method | Box, Carton |

Product Compliance

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU | Compliant |
|---|---|
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC |
| Halogen Content | Not Low Halogen - contains Br or Cl > 900 ppm. |
| Solder Process Capability | Wave solder capable to 265°C |

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products



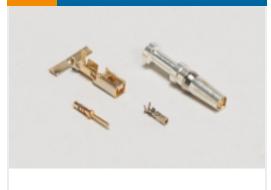
will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | AMPMODU Headers





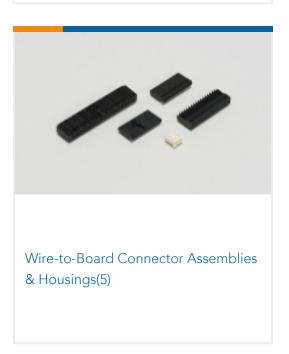




Connector Contacts(64)

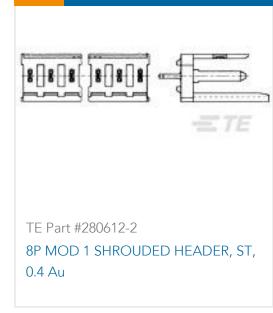
Connector Hardware(2)

PCB Headers & Receptacles(3204)



Customers Also Bought





















Documents

Product Drawings

4P AMPMODU II SHRD HDR, ST, 0.38AU

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_280371-2_U_c-280371-2-u.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_280371-2_U_c-280371-2-u.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_280371-2_U_c-280371-2-u.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Test Specification

English